

Automotive MOSFET

OptiMOS™-5 Power-Transistor







Features

- OptiMOS[™] power MOSFET for automotive applications
- N-channel Enhancement mode Normal Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green product (RoHS compliant)
- 100% Avalanche tested



General automotive applications.



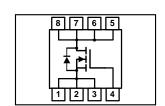
Qualified for automotive applications. Product validation according to AEC-Q101.

Product Summary

| $V_{ m DS}$ | 60 | V |
|-------------------------------|------|----|
| R _{DS(on)} | 10.5 | mΩ |
| I _D (chip limited) | 40 | Α |

| Туре | Package | Marking |
|-----------------|----------------|---------|
| IAUZ40N06S5N105 | PG-TSDSON-8-32 | 5N06105 |





IAUZ40N06S5N105



Table of Contents

| Description | 1 |
|-------------------------------------|------|
| Maximum ratings | . 3 |
| Thermal characteristics | . 4 |
| Electrical characteristics | . 4 |
| Electrical characteristics diagrams | . 6 |
| Package outline & footprint | 10 |
| Revision history | . 11 |
| Disclaimer | . 12 |

IAUZ40N06S5N105



Maximum ratings

at Tj=25 °C, unless otherwise specified

| at 1]-23 C, unless otherwise specified | | | | | | | |
|--|-----------------------------|--|-----------|------|--|--|--|
| Parameter | Symbol | Conditions | Value | Unit | | | |
| Continuous drain current | I _D | V _{GS} =10 V, Chip limitation ^{1,2)} | 40 | А | | | |
| | | V _{GS} =10V, DC current | 40 | | | | |
| | | T_a =85 °C, V_{GS} =10 V, R_{thJA} on 2s2p ^{2,4)} | 8 | | | | |
| Pulsed drain current ²⁾ | / _{D,pulse} | $T_{\rm C}$ =25 °C, $t_{\rm p}$ = 100 μ s | 120 | 1 | | | |
| Avalanche energy, single pulse ²⁾ | E AS | / _D =20 A | 37 | mJ | | | |
| Avalanche current, single pulse | I _{AS} | - | 40 | А | | | |
| Gate source voltage | V _{GS} | - | ±20 | V | | | |
| Power dissipation | P _{tot} | T _C =25 °C | 42 | W | | | |
| Operating and storage temperature | $T_{\rm j}$, $T_{\rm stg}$ | - | -55 +175 | °C | | | |
| IEC climatic category; DIN IEC 68-1 | - | - | 55/175/56 | | | | |

IAUZ40N06S5N105



Thermal characteristics²⁾

| Parameter | Symbol | Conditions | Values | | | Unit |
|--|-------------------|------------|--------|------|------|------|
| | | | min. | typ. | max. | |
| Thermal resistance, junction - case | R thJC | - | _ | _ | 3.6 | K/W |
| Thermal resistance, junction - ambient ⁴⁾ | R _{thJA} | - | - | 40 | _ | |

Electrical characteristics

at Tj=25 °C, unless otherwise specified

| Parameter | Symbol Conditions | | Values | | | Unit |
|----------------------------------|----------------------|---|--------|------|------|------|
| | | | min. | typ. | max. | |
| Static characteristics | | | | | | |
| Drain-source breakdown voltage | V _{(BR)DSS} | V_{GS} =0 V, I_D =1 mA | 60 | _ | - | V |
| Gate threshold voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 13 \mu A$ | 2.2 | 2.8 | 3.4 | |
| Zero gate voltage drain current | I _{DSS} | $V_{\rm DS}$ =60 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C | - | _ | 1 | μΑ |
| | | V_{DS} =60 V, V_{GS} =0 V, T_{j} =100 °C ²⁾ | - | _ | 100 | |
| Gate-source leakage current | I _{GSS} | V _{GS} =20 V, V _{DS} =0 V | - | - | 100 | nA |
| Drain-source on-state resistance | R _{DS(on)} | V_{GS} =7 V, I_{D} =10 A | _ | 10.7 | 12.8 | mΩ |
| | | V _{GS} =10 V, I _D =20 A | _ | 8.7 | 10.5 | |
| Gate resistance ²⁾ | R _G | - | - | 1.28 | _ | Ω |

IAUZ40N06S5N105



| Parameter | Symbol Conditions | | Values | | | Unit |
|---|----------------------|---|--------|------|------|------|
| | | | min. | typ. | max. | |
| Dynamic characteristics ²⁾ | | | | | | |
| Input capacitance | C iss | | - | 845 | 1099 | pF |
| Output capacitance | C oss | V_{GS} =0 V, V_{DS} =30 V, f =1 MHz | - | 192 | 250 | |
| Reverse transfer capacitance | C _{rss} | | - | 12 | 18 | 1 |
| Turn-on delay time | t d(on) | | - | 2.8 | _ | ns |
| Rise time | t _r | V_{DD} =30 V, V_{GS} =10 V, I_{D} =20 A, | - | 1.0 | _ | |
| Turn-off delay time | t d(off) | $R_{\rm G}$ =3.5 Ω | - | 3.9 | _ | |
| Fall time | t f | | _ | 2.2 | _ | |
| Gate to drain charge | Q _{gd} | V _{DD} =30 V, I _D =20 A, | _ | 2.8 | 4.1 | |
| | | $V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V | | | | |
| Gate charge total | Q _g | - 63 0 00 10 1 | | 12.6 | 16.3 | |
| Gate plateau voltage | $V_{\rm plateau}$ | | - | 4.9 | _ | V |
| Reverse Diode | | | | | | |
| Diode continous forward current ²⁾ | Is | т _с =25 °С | _ | _ | 40 | A |
| Diode pulse current ²⁾ | I _{S,pulse} | T _C =25 °C, t _p = 100 μs | - | _ | 120 | |
| Diode forward voltage | V _{SD} | V _{GS} =0 V, I _F =20 A, T _j =25 °C | - | 0.8 | 1.1 | V |
| Reverse recovery time ²⁾ | t rr | V _R =40 V, I _F =40 A, | - | 30 | _ | ns |
| Reverse recovery charge ²⁾ | Q _{rr} | $di_F/dt = 100 A/\mu s$ | _ | 22.7 | _ | nC |

¹⁾ Practically the current is limited by the overall system design including the customer-specific PCB.

 $^{^{2)}\,\}mbox{The parameter}$ is not subject to production testing – specified by design.

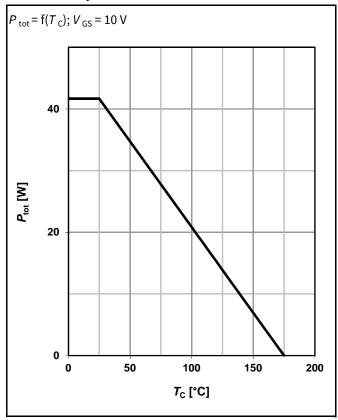
³⁾ Current is limited by the package.

 $^{^{4)}}$ Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

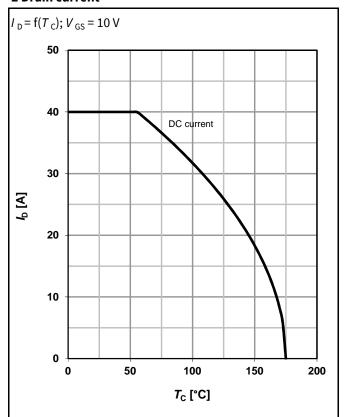


Electrical characteristics diagrams

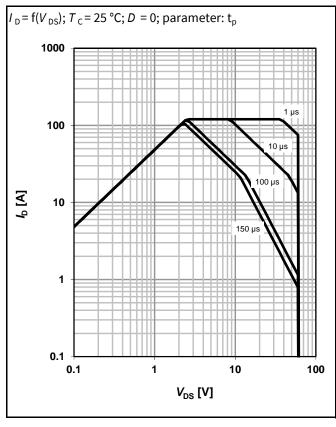
1 Power dissipation



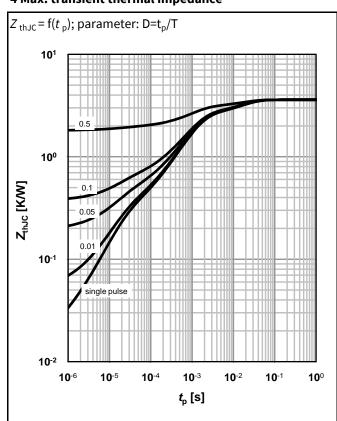
2 Drain current



3 Safe operating area

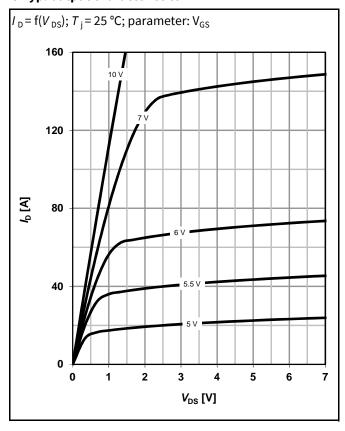


4 Max. transient thermal impedance

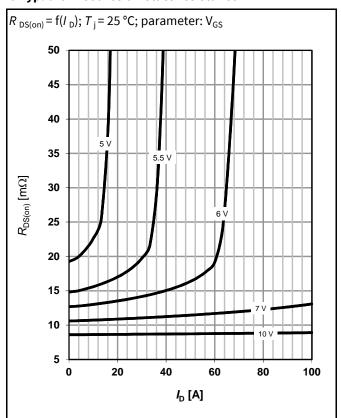




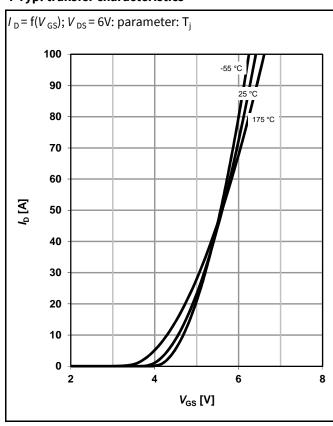
5 Typ. output characteristics



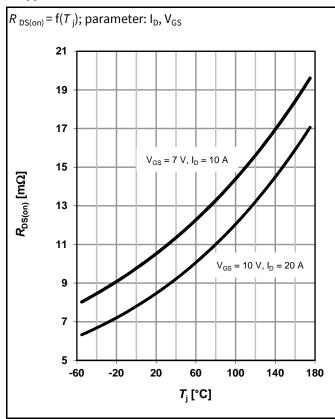
6 Typ. drain-source on-state resistance



7 Typ. transfer characteristics

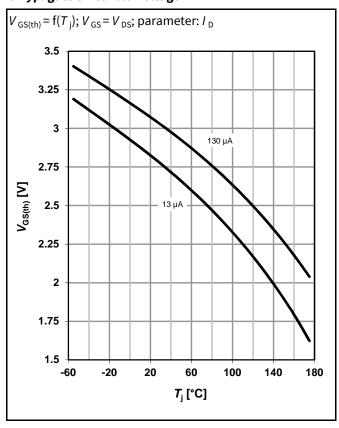


8 Typ. drain-source on-state resistance

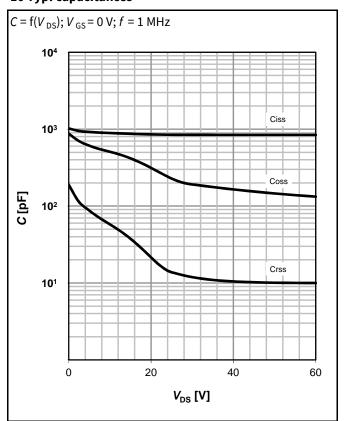


infineon

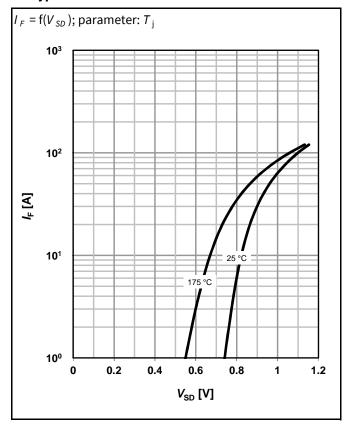
9 Typ. gate threshold voltage



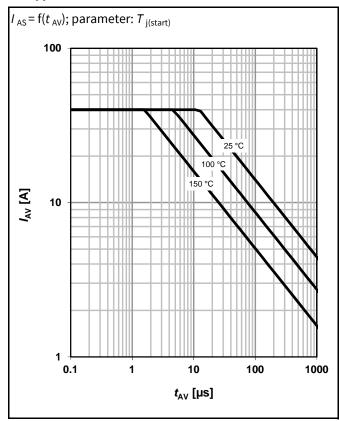
10 Typ. capacitances



11 Typical forward diode characteristics

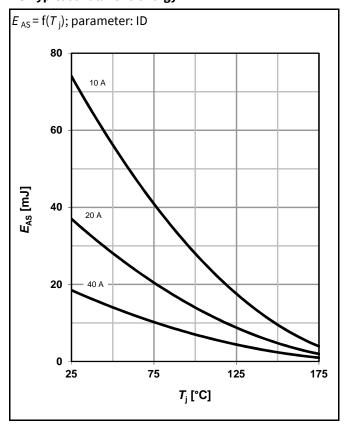


12 Typ. avalanche characteristics

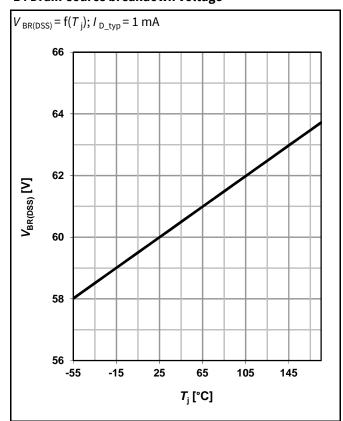


infineon

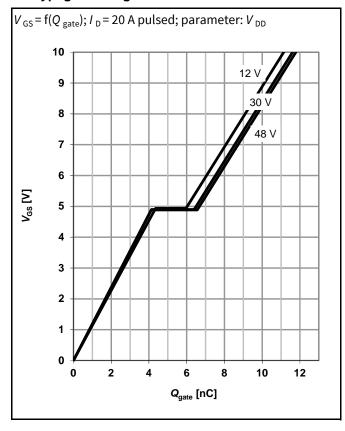
13 Typical avalanche energy



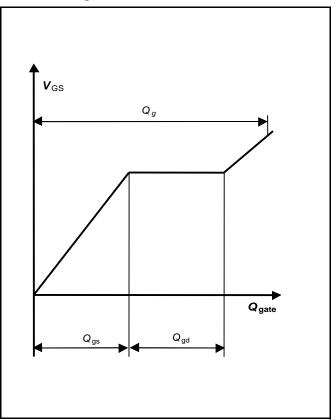
14 Drain-source breakdown voltage



15 Typ. gate charge



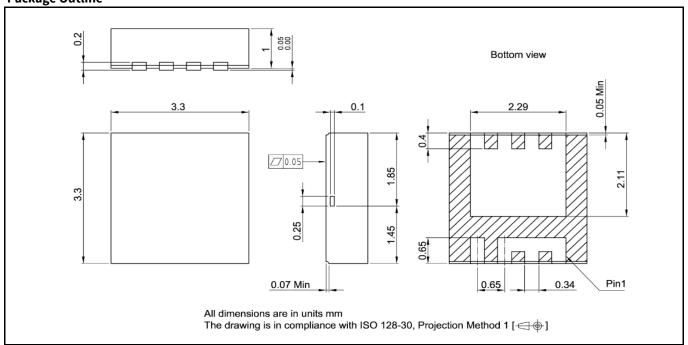
16 Gate charge waveforms



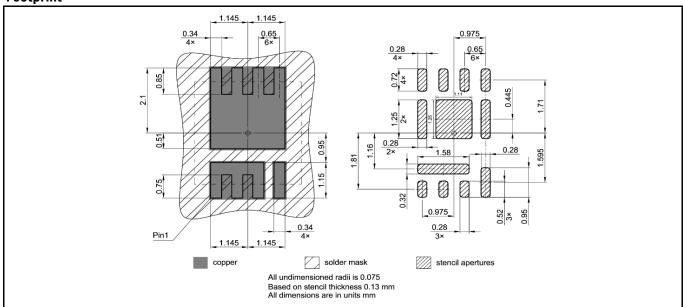
IAUZ40N06S5N105



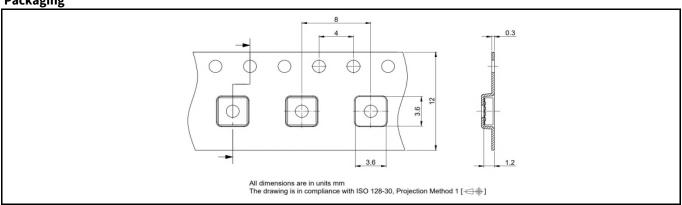
Package Outline



Footprint



Packaging



IAUZ40N06S5N105



Revision History

| Revision | Date | Changes |
|--------------|------------|---|
| Revision 1.0 | 04.05.2021 | final data sheet |
| Revision 1.1 | 07.05.2021 | marking (page 1) |
| | | updata image for pin layout (page 1), |
| Revision 1.2 | 27.01.2022 | update thermal characteristics (page 4) |

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

Edition 2021-05-04

Published by

Infineon Technologies AG

81726 Munich, Germany

© 2021 Infineon Technologies AG

All Rights Reserved.

Do you have any questions about any aspect of this document?

Email: erratum@infineon.com

IMPORTANT NOTICE

regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications. The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

The information given in this document shall in no event be For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (<u>www.infineon.com</u>).

WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact the nearest Infineon Technologies

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal